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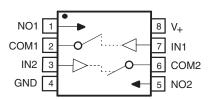
DUAL-CHANNEL 10-Ω SPST ANALOG SWITCH

Check for Samples: TS5A2066

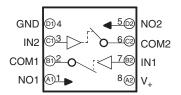
FEATURES

- Low ON-State Resistance (10 Ω)
- Control Inputs Are 5-V Tolerant
- Low Charge Injection
- Excellent ON-State Resistance Matching
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)

DCT OR DCU PACKAGE (TOP VIEW)



YZP PACKAGE (BOTTOM VIEW)



APPLICATIONS

- Sample-and-Hold Circuits
- Battery-Powered Equipment
- Audio and Video Signal Routing
- Communication Circuits
- Cell Phones
- Low-Voltage Data-Acquisition Systems
- PDAs

DESCRIPTION/ORDERING INFORMATION

The TS5A2066 is a dual single-pole single-throw (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. This device can handle both digital and analog signals, and signals up to V_{+} can be transmitted in either direction.

Table 1. Summary of Characteristics (1)

| Configuration | Dual Single Pole Single Throw (2 × SPST) | | | | |
|---|--|--|--|--|--|
| Number of channels | 2 | | | | |
| ON-state resistance (ron) | 7.5 Ω | | | | |
| ON-state resistance match (Δr _{on}) | 0.4 Ω | | | | |
| ON-state resistance flatness (r _{on(flat)}) | 3.5 Ω | | | | |
| Turn-on/turn-off time (t _{ON} /t _{OFF}) | 5.8 ns/3.6 ns | | | | |
| Charge injection (Q _C) | 1 pC | | | | |
| Bandwidth (BW) | 400 MHz | | | | |
| OFF isolation (O _{ISO}) | –68 dB | | | | |
| Crosstalk (X _{TALK}) | –66 dB | | | | |
| Total harmonic distortion (THD) | 0.01% | | | | |
| Leakage current (I _{COM(OFF)} /(I _{NC(OFF)} | ±50 nA | | | | |
| Power-supply current (I+) | 0.1 μΑ | | | | |
| Package options | 8-pin DSBGA, SSOP, or VSSOP | | | | |

(1) $V_+ = 5 \text{ V} \text{ and } T_A = 25^{\circ}\text{C}$



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ORDERING INFORMATION(1)

| T _A | PACKAGE ⁽²⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING ⁽³⁾ |
|----------------|--|--------------|--------------------------|---------------------------------|
| | NanoFree [™] – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free) | | TS5A2066YZPR | J4_ |
| -40°C to 85°C | SSOP - DCT | Reel of 3000 | TS5A2066DCTR | JAG |
| | VSSOP - DCU | Reel of 3000 | TS5A2066DCUR | JAG_ |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
- (3) DCT: The actual top-side marking has three additional characters that designate the year, month, and wafer fab/assembly site. DCU: The actual top-side marking has one additional character that designates the wafer fab/assembly site.

 YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the wafer fab/assembly site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, = Pb-free).

FUNCTION TABLE

| IN | NO TO COM, COM TO NO |
|----|-------------------------|
| L | OFF |
| Н | ON |

Absolute Minimum and Maximum Ratings(1) (2)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|--------------------|---|--|------|----------------------|------|
| V ₊ | Supply voltage range ⁽³⁾ | | -0.5 | 6.5 | V |
| $V_{NO} \ V_{COM}$ | Analog voltage range ⁽³⁾ (4) (5) | | -0.5 | V ₊ + 0.5 | V |
| I _K | Analog port diode current | V_{NO} , $V_{COM} < 0$ or V_{NO} , $V_{COM} > V_{+}$ | -50 | 50 | mA |
| I_{NO} I_{COM} | On-state switch current | V_{NO} , $V_{COM} = 0$ to V_{+} | -50 | 50 | mA |
| VI | Digital input voltage range (3) (4) | • | -0.5 | 6.5 | V |
| I _{IK} | Digital input clamp current | V _I < 0 | -50 | | mA |
| I ₊ | Continuous current through V ₊ | | | 100 | mA |
| I_{GND} | Continuous current through GND | | -100 | 100 | mA |
| | | DCT package | | 220 | |
| θ_{JA} | Package thermal impedance (6) | DCU package | | 227 | °C/W |
| | | YZP package | | 102 | |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (5) This value is limited to 5.5 V maximum.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.



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Electrical Characteristics for 5-V Supply⁽¹⁾

 $V_{+} = 4.5 \text{ V to } 5.5 \text{ V}, T_{A} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C} \text{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST | CONDITIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|--|------------------------------------|--|------------------------------|----------------|----------------|----------------------|------|----------------------|------|
| Analog Switch | | | | • | | | | • | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V ₊ | V |
| ON-state resistance | r _{on} | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -32 \text{ mA},$ | Switch ON, See Figure 13 | 25°C Full | 4.5 V | | 7.5 | 10 15 | Ω |
| ON-state | | | | 25°C | | | 0.4 | 1 | |
| resistance match between channels | Δr _{on} | $V_{NO} = 3.15 \text{ V},$ $I_{COM} = -32 \text{ mA},$ | Switch ON, SeeFigure 13 | Full | 4.5 V | | | 3 | Ω |
| ON-state | | 0 ≤ V _{NO} ≤ V ₊ , | Switch ON, | 25°C | | 2 | 3.5 | 5 | |
| resistance flatness | r _{on(flat)} | $I_{COM} = -32 \text{ mA},$ | See Figure 13 | Full | 4.5 V | 4 | | 8 | Ω |
| | | V _{NO} = 1 V, | | 25°C | | -30 | -10 | 30 | |
| NO OFF leakage current | I _{NO(OFF)} | $V_{COM} = 4.5 \text{ V},$ or $V_{NO} = 4.5 \text{ V},$ $V_{COM} = 1 \text{ V},$ | Switch OFF, See Figure 14 | Full | 5.5 V | -40 | | 40 | nA |
| | | V _{COM} = 1 V, | | 25°C | | -50 | -8 | 50 | |
| COM OFF leakage current | I _{COM(OFF)} | $V_{NO} = 4.5 \text{ V},$ or $V_{COM} = 4.5 \text{ V},$ $V_{NO} = 1 \text{ V},$ | Switch OFF, See Figure 14 | Full | 5.5 V | -50 | | 50 | nA |
| | | V _{NO} = 1 V, | | 25°C | | -40 | -12 | 40 | |
| NO ON leakage current | I _{NO(ON)} | V_{COM} = Open, or V_{NO} = 4.5 V, V_{COM} = Open | Switch ON, See Figure 15 | Full | 5.5 V | -4 | | 40 | nA |
| | | $V_{COM} = 1 V$, | | 25°C | | -70 | -30 | 70 | |
| COM ON leakage current | I _{COM(ON)} | V_{NO} = Open, or V_{COM} = 4.5 V, V_{NO} = Open, | Switch ON, See Figure 15 | Full | 5.5 V | -70 | | 70 | nA |
| Digital Control In | put (IN) | | | | | | | | |
| Input logic high | V _{IH} | | | Full | | V ₊ × 0.7 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | V ₊ × 0.3 | V |
| Input leakage current | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | 25°C | 5.5 V | -0.1 | 0.05 | 0.1 | μА |
| Currelli | | | | Full | | -1 | | 1 | • |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 5-V Supply (1) (continued)

 $V_+ = 4.5 \text{ V to } 5.5 \text{ V}, T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST C | ONDITIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|---|----------------|-------------------|-----|------|-----|------|
| Dynamic | | | | | | | | | |
| | | V 0.V | 0 05 -5 | 25°C | 5 V | 4.4 | 5.2 | 5.8 | |
| Turn-on time | t _{ON} | $V_{COM} = 3 \text{ V},$ $R_L = 300 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 4.5 V to 5.5 V | 3.4 | | 6.1 | ns |
| | | V 2.V | 0 25 25 | 25°C | 5 V | 1.7 | 2.6 | 3.6 | |
| Turn-off time | t _{OFF} | $V_{COM} = 3 \text{ V},$ $R_L = 300 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 4.5 V to 5.5 V | 1.3 | | 4.2 | ns |
| Charge injection | Q _C | $V_{GEN} = 0,$ $R_{GEN} = 0,$ | C _L = 0.1 nF, See Figure 21 | 25°C | 5 V | | 1 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 5 V | | 5.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{COM} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 5 V | | 5.5 | | pF |
| NO ON capacitance | C _{NO(ON)} | $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 16 | 25°C | 5 V | | 13.5 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 5 V | | 13.5 | | pF |
| Digital input capacitance | Cı | $V_I = V_+ \text{ or GND},$ | See Figure 16 | 25°C | 5 V | | 2.5 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 5 V | | 300 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 5 V | | -68 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, f = 10 MHz, | Switch ON, See Figure 20 | 25°C | 5 V | | -66 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 20 Hz to 20 kHz, See Figure 22 | 25°C | 5 V | | 0.01 | | % |
| Supply | | | | • | <u> </u> | | | | |
| Positive supply | | V V OND | Owital ON as OFF | 25°C | 5.5.1 | | 0.1 | 1 | ^ |
| current | I ₊ | $V_I = V_+ \text{ or GND},$ | Switch ON or OFF | Full | 5.5 V | | | 5 | μΑ |

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Electrical Characteristics for 3.3-V Supply⁽¹⁾

 $V_{+} = 3 \text{ V to } 3.6 \text{ V}, T_{A} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C} \text{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST (| CONDITIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|---|------------------------------------|--|------------------------------|----------------|----------------|----------------------|------------|----------------------|------|
| Analog Switch | | * | | | | | | * | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V ₊ | V |
| ON-state | r | $0 \le V_{NO} \le V_+$ | Switch ON, | 25°C | 3 V | 10 | 12 | 15 | Ω |
| resistance | r _{on} | $I_{COM} = -24 \text{ mA},$ | See Figure 13 | Full | 3 v | 12 | | 20 | 32 |
| ON-state | | | | 25°C | | 0.04 | 0.5 | 1.5 | |
| resistance match between channels | Δr_{on} | $V_{NO} = 2.1 \text{ V},$ $I_{COM} = -24 \text{ mA},$ | Switch ON, See Figure 13 | Full | 3 V | 0.01 | | 3.5 | Ω |
| ON-state | | 0 ≤ V _{NO} ≤ V ₊ , | Switch ON. | 25°C | | 6 | 7 | 8 | |
| resistance flatness | r _{on(flat)} | $I_{COM} = -24 \text{ mA},$ | See Figure 13 | Full | 3 V | 9 | | 12 | Ω |
| | | V _{NO} = 1 V, | | 25°C | | -30 | -6 | 30 | |
| NO OFF leakage current | I _{NO(OFF)} | $V_{COM} = 3 \text{ V},$ or $V_{NO} = 3 \text{ V},$ $V_{COM} = 1 \text{ V},$ | Switch OFF, See Figure 14 | Full | 3.6 V | -40 | | 40 | nA |
| | | $V_{COM} = 1 V$, | | 25°C | | -50 | -7 | 50 | |
| COM OFF leakage current | I _{COM(OFF)} | $V_{NO} = 3 V$, or $V_{COM} = 3 V$, $V_{NO} = 1 V$, | Switch OFF, See Figure 14 | Full | 3.6 V | -50 | | 50 | nA |
| _ | | V _{NO} = 1 V, | | 25°C | | -40 | - 7 | 40 | |
| NO ON leakage current | I _{NO(ON)} | $V_{COM} = Open,$ or $V_{NO} = 3 V,$ $V_{COM} = Open,$ | Switch ON, See Figure 15 | Full | 3.6 V | -40 | | 40 | nA |
| | | $V_{COM} = 1 V$, | | 25°C | | -70 | -20 | 70 | |
| COM ON leakage current | I _{COM(ON)} | V_{NO} = Open, or V_{COM} = 3 V, V_{NO} = Open, | Switch ON, See Figure 15 | Full | 3.6 V | -70 | | 70 | nA |
| Digital Control In | put (IN) | | | | | | | | |
| Input logic high | V _{IH} | | | Full | - | V ₊ × 0.7 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | V ₊ × 0.3 | V |
| Input leakage current | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | 25°C Full | 3.6 V | -0.1 -1 | 0.05 | 0.1 | μΑ |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 3.3-V Supply ⁽¹⁾ (continued) $V_+ = 3 \text{ V to } 3.6 \text{ V}, T_A = -40^{\circ}\text{C to } 85^{\circ}\text{C (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST CO | NDITIONS | T _A | ٧, | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|--|----------------|-----------------|-----|-------|-----|------|
| Dynamic | | | | | | | | | |
| | | V 2.V | 0 25 25 | 25°C | 3.3 V | 4.9 | 5.6 | 6.4 | |
| Turn-on time | t _{ON} | $V_{COM} = 2 V,$ $R_L = 300 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 3 V to 3.6 V | 4.3 | | 7.1 | ns |
| | | V _{COM} = 2 V, | $C_L = 35 \text{ pF},$ | 25°C | 3.3 V | 2 | 2.7 | 3.7 | |
| Turn-off time | t _{OFF} | $R_L = 300 \Omega$ | See Figure 17 | Full | 3 V to 3.6 V | 1.3 | | 4.7 | ns |
| Charge injection | $Q_{\mathbb{C}}$ | $V_{GEN} = 0,$ $R_{GEN} = 0,$ | $C_L = 0.1 \text{ nF},$ See Figure 21 | 25°C | 3.3 V | | 0.5 | | pC |
| NO OFF capacitance | $C_{NO(OFF)}$ | $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 16 | 25°C | 3.3 V | | 5.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{COM} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 3.3 V | | 6 | | pF |
| NO ON capacitance | C _{NO(ON)} | $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 16 | 25°C | 3.3 V | | 14 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 3.3 V | | 14 | | pF |
| Digital input capacitance | Cı | $V_I = V_+$ or GND, | See Figure 16 | 25°C | 3.3 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 3.3 V | | 300 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 3.3 V | | -68 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, $f = 10 MHz$, | Switch ON, See Figure 20 | 25°C | 3.3 V | | -66 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 20 Hz to 20 kHz, See Figure 22 | 25°C | 3.3 V | | 0.065 | | % |
| Supply | | | | | | | | | |
| Positive supply current | I ₊ | $V_I = V_+ \text{ or GND},$ | Switch ON or OFF | 25°C Full | 3.6 V | | 0.1 | 1 5 | μΑ |

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Electrical Characteristics for 2.5-V Supply⁽¹⁾

 $V_{+} = 2.3 \text{ V}$ to 2.7 V, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted)

| PARAMETER | SYMBOL | TES1 | CONDITIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|---|------------------------------------|--|------------------------------|----------------|----------------|----------------------|------------|----------------------|------|
| Analog Switch | | | | | | | | | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V ₊ | V |
| ON-state | r _{on} | $0 \le V_{NO} \le V_+$ | Switch ON, | 25°C | 2.3 V | 20 | 22 | | Ω |
| resistance | on | $I_{COM} = -8 \text{ mA},$ | See Figure 13 | Full | 2.0 V | | | 30 | 32 |
| ON-state | | | | 25°C | | 0.04 | 0.5 | 1.5 | |
| resistance match between channels | Δr _{on} | $V_{NO} = 1.6 \text{ V},$ $I_{COM} = -8 \text{ mA},$ | Switch ON, SeeFigure 13 | Full | 2.3 V | 0.02 | | 5 | Ω |
| ON-state | | 0 ≤ V _{NO} ≤ V ₊ , | Switch ON. | 25°C | | 12 | 16 | 18 | |
| resistance flatness | r _{on(flat)} | $I_{COM} = -8 \text{ mA},$ | See Figure 13 | Full | 2.3 V | 15 | | 25 | Ω |
| | | $V_{NO} = 0.5 V,$ | | 25°C | | -30 | -5.5 | 30 | |
| NO OFF leakage current | I _{NO(OFF)} | $V_{COM} = 2.2 \text{ V},$ or $V_{NO} = 2.2 \text{ V},$ $V_{COM} = 0.5 \text{ V},$ | Switch OFF, See Figure 14 | Full | 2.7 V | -40 | | 40 | nA |
| | | $V_{COM} = 0.5 \text{ V},$ | | 25°C | | -50 | -7.5 | 50 | |
| COM OFF leakage current | I _{COM(OFF)} | $V_{NO} = 2.2 \text{ V},$ or $V_{COM} = 2.2 \text{ V},$ $V_{NO} = 0.5 \text{ V},$ | Switch OFF, See Figure 14 | Full | 2.7 V | -50 | | 50 | nA |
| | | $V_{NO} = 0.5 V,$ | | 25°C | | -40 | - 5 | 40 | |
| NO ON leakage current | I _{NO(ON)} | $V_{COM} = Open,$ or $V_{NO} = 2.2 \text{ V},$ $V_{COM} = Open,$ | Switch ON, See Figure 15 | Full | 2.7 V | -40 | | 40 | nA |
| | | $V_{COM} = 0.5 \text{ V},$ | | 25°C | | -70 | -12 | 70 | |
| COM ON leakage current | I _{COM(ON)} | V_{NO} = Open, or V_{COM} = 2.2 V, V_{NO} = Open, | Switch ON, See Figure 15 | Full | 2.7 V | -70 | | 70 | nA |
| Digital Control In | put (IN) | | | | | | | | |
| Input logic high | V _{IH} | | | Full | | V ₊ × 0.7 | | 5.5 | V |
| Input logic low | V_{IL} | | | Full | | 0 | | V ₊ × 0.3 | V |
| Input leakage current | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | 25°C Full | 2.7 V | -0.1 -1 | 0.05 | 0.1 | μΑ |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 2.5-V Supply ⁽¹⁾ (continued) $V_{+} = 2.3 \text{ V}$ to 2.7 V, $T_{A} = -40 ^{\circ}\text{C}$ to 85°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST C | ONDITIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|--|----------------|-------------------|-----|------|----------|------|
| Dynamic | | • | | | | | | * | |
| | | V 4.5.V | 0 25 55 | 25°C | 2.5 V | 5.7 | 6.4 | 8.1 | |
| Turn-on time | t _{ON} | $V_{COM} = 1.5 \text{ V},$ $R_L = 300 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 2.3 V to 2.7 V | 4.4 | | 8.5 | ns |
| | | V -15 V | C - 25 nE | 25°C | 2.5 V | 2.1 | 3.1 | 4.3 | |
| Turn-off time | t _{OFF} | $V_{COM} = 1.5 \text{ V},$ $R_L = 300 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 2.3 V to 2.7 V | 1.8 | | 4.8 | ns |
| Charge injection | $Q_{\mathbb{C}}$ | $V_{GEN} = 0,$ $R_{GEN} = 0,$ | $C_L = 0.1 \text{ nF},$ See Figure 20 | 25°C | 2.5 V | | 0.5 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 16 | 25°C | 2.5 V | | 6 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{COM} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 2.5 V | | 6 | | pF |
| NO ON capacitance | C _{NO(ON)} | $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 16 | 25°C | 2.5 V | | 14 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 2.5 V | | 14 | | pF |
| Digital input capacitance | Cı | $V_I = V_+$ or GND, | See Figure 16 | 25°C | 2.5 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 2.5 V | | 300 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 2.5 V | | -68 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, f = 10 MHz, | Switch ON, See Figure 20 | 25°C | 2.5 V | | -66 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 20 Hz to 20 kHz, See Figure 22 | 25°C | 2.5 V | | 0.35 | | % |
| Supply | | | | | | | | <u> </u> | |
| Positive supply | | V V OND | Owitals ON as OFF | 25°C | 0.7.1/ | | 0.1 | 1 | ^ |
| current | I ₊ | $V_I = V_+ \text{ or GND},$ | Switch ON or OFF | Full | 2.7 V | | | 5 | μΑ |

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Electrical Characteristics for 1.8-V Supply⁽¹⁾

 V_{+} = 1.65 V to 1.95 V, T_{A} = -40°C to 85°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST (| CONDITIONS | TA | V ₊ | MIN | TYP | MAX | UNIT |
|--|------------------------------------|--|------------------------------|------|----------------|-----------------------|------|-----------------------|------|
| Analog Switch | | • | | • | | | | | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V ₊ | V |
| ON-state | · | $0 \le V_{NO} \le V_+$ | Switch ON, | 25°C | 1.65 V | 80 | 85 | | Ω |
| resistance | r _{on} | $I_{COM} = -4 \text{ mA},$ | See Figure 13 | Full | 1.05 V | 90 | | 120 | 12 |
| ON-state | | | | 25°C | | 0 | 0.9 | 2 | |
| resistance match between channels | Δr_{on} | $V_{NO} = 1.15 \text{ V},$ $I_{COM} = -4 \text{ mA},$ | Switch ON, See Figure 13 | Full | 1.65 V | 0 | | 6 | Ω |
| ON-state | | 0 ≤ V _{NO} ≤ V ₊ , | Switch ON, | 25°C | | 70 | 75 | 85 | |
| resistance flatness | r _{on(flat)} | $I_{COM} = -4 \text{ mA},$ | See Figure 13 | Full | 1.65 V | 85 | | 100 | Ω |
| | | $V_{NO} = 0.3 V$, | | 25°C | | -30 | -6 | 30 | |
| NO OFF leakage current | I _{NO(OFF)} | $V_{COM} = 1.65 \text{ V},$ or $V_{NO} = 1.65 \text{ V},$ $V_{COM} = 0.3 \text{ V},$ | Switch OFF, See Figure 14 | Full | 1.95 V | -40 | | 40 | nA |
| | | $V_{COM} = 0.3 V,$ | | 25°C | | -50 | -7 | 50 | |
| COM OFF leakage current | I _{COM(OFF)} | $V_{NO} = 1.65 \text{ V},$ or $V_{COM} = 1.65 \text{ V},$ $V_{NO} = 0.3 \text{ V},$ | Switch OFF, See Figure 14 | Full | 1.95 V | -50 | | 50 | nA |
| | | $V_{NO} = 0.3 V$, | | 25°C | | -40 | 7 | 40 | |
| NO ON leakage current | I _{NO(ON)} | $V_{COM} = Open,$ or $V_{NO} = 1.65 V,$ $V_{COM} = Open,$ | Switch ON, See Figure 15 | Full | 1.95 V | -40 | | 40 | nA |
| | | $V_{COM} = 0.3 \text{ V},$ | | 25°C | | -70 | -8.5 | 70 | |
| COM ON leakage current | I _{COM(ON)} | V_{NO} = Open, or V_{COM} = 1.65 V, V_{NO} = Open, | Switch ON, See Figure 15 | Full | 1.95 V | -70 | | 70 | nA |
| Digital Control In | put (IN) | | | • | | | | | |
| Input logic high | V _{IH} | | | Full | | V ₊ × 0.65 | | 5.5 | V |
| Input logic low | V_{IL} | | | Full | | 0 | | V ₊ × 0.35 | V |
| Input leakage | 1 1 | V - F F V or 0 | | 25°C | 1.95 V | -0.1 | 0.05 | 0.1 | ^ |
| current | I _{IH} , I _{IL} | $V_1 = 5.5 \text{ V or } 0$ | | Full | 1.95 V | -1 | | 1 | μΑ |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 1.8-V Supply ⁽¹⁾ (continued) $V_+ = 1.65 \text{ V}$ to 1.95 V, $T_A = -40 ^{\circ}\text{C}$ to 85°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST C | ONDITIONS | TA | ٧, | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|---|--|--------------|---------------------------------|------------|------|------------|------|
| Dynamic | | - | | • | - | | | * | |
| Turn-on time | t _{ON} | $V_{COM} = 1.3 \text{ V},$ $R_L = 300 \Omega,$ | C _L = 35 pF, See Figure 17 | 25°C Full | 1.8 V 1.65 V to 1.95 V | 9.3 | 10.4 | 11.5 | ns |
| Turn-off time | t _{OFF} | $V_{COM} = 1.3 \text{ V},$ $R_L = 300 \Omega,$ | C _L = 35 pF, See Figure 17 | 25°C Full | 1.8 V 1.65 V to 1.95 V | 3.3 2.4 | 4.3 | 5.2 6.5 | ns |
| Charge injection | $Q_{\mathbb{C}}$ | $V_{GEN} = 0,$ $R_{GEN} = 0,$ | $C_L = 0.1 \text{ nF},$ See Figure 21 | 25°C | 1.8 V | | 0.5 | | pC |
| NO OFF capacitance | C _{NO(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 1.8 V | | 6 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{COM} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 1.8 V | | 6 | | pF |
| NO ON capacitance | C _{NO(ON)} | V _{NO} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 1.8 V | | 14.5 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 1.8 V | | 14.5 | | pF |
| Digital input capacitance | C _I | $V_I = V_+ \text{ or GND},$ | See Figure 16 | 25°C | 1.8 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 1.8 V | | 293 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 1.8 V | | -68 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, $f = 10 MHz$, | Switch ON, See Figure 20 | 25°C | 1.8 V | | -66 | | dB |
| Total harmonic distortion | THD | $R_L = 10 \text{ k}\Omega,$ $C_L = 50 \text{ pF},$ | f = 20 Hz to 20 kHz, See Figure 22 | 25°C | 1.8 V | | 2.7 | | % |
| Supply | | | | • | | | | | |
| Positive supply current | I ₊ | $V_I = V_+ \text{ or GND},$ | Switch ON or OFF | 25°C Full | 1.95 V | | 0.1 | 1 5 | μΑ |

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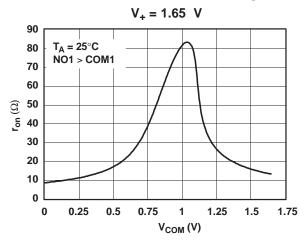
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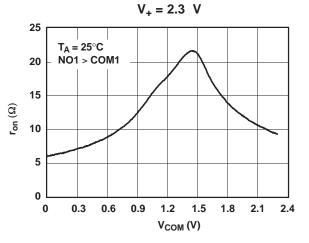
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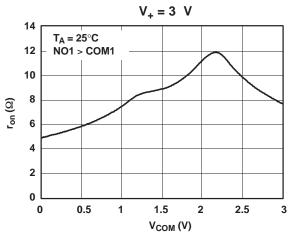
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TYPICAL PERFORMANCE







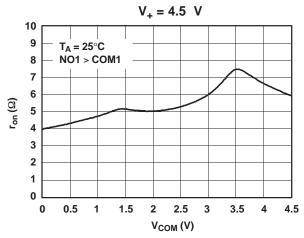


Figure 1. ron vs V_{COM}

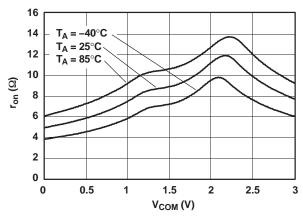


Figure 2. r_{on} vs V_{COM} ($V_{+} = 3 \text{ V}$)

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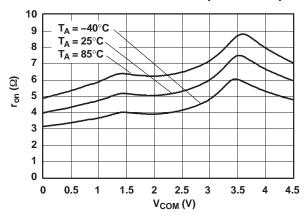


Figure 3. r_{on} vs V_{COM} (V_{+} = 4.5 V)

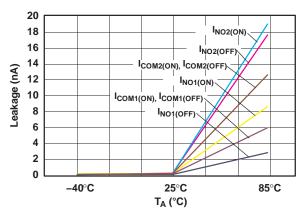


Figure 4. Leakage Current vs Temperature

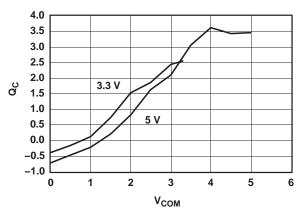


Figure 5. Charge Injection (Q_C) vs V_{COM}

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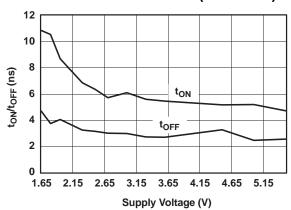


Figure 6. toN and toFF vs V+

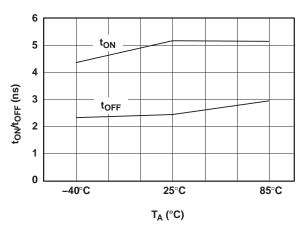


Figure 7. t_{ON} and t_{OFF} vs Temperature (V₊ = 5 V)

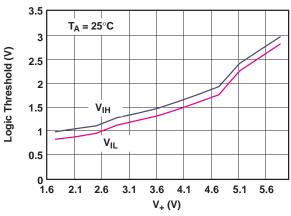


Figure 8. Logic Threshold vs V₊

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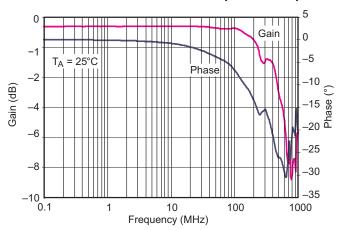


Figure 9. Bandwidth $(V_+ = 5 V)$

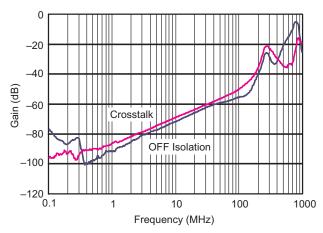


Figure 10. OFF Isolation and Crosstalk ($V_{+} = 5 \text{ V}$)

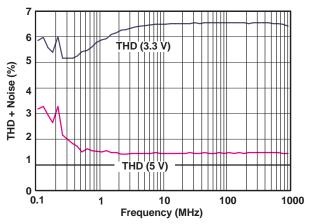


Figure 11. Total Harmonic Distortion vs Frequency

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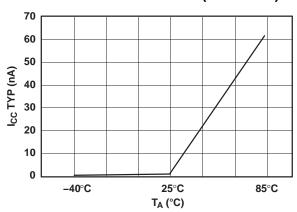


Figure 12. Power-Supply Current vs Temperature $(V_+ = 5 V)$



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Table 2. PIN DESCRIPTION

| NO. | NAME | DESCRIPTION | | | | | |
|-----|---------|--------------------------------------|--|--|--|--|--|
| 1 | NO1 | Normally open | | | | | |
| 2 | COM1 | Common | | | | | |
| 3 | IN2 | igital control to connect COM to NO | | | | | |
| 4 | GND | Digital ground | | | | | |
| 5 | NO2 | Normally open | | | | | |
| 6 | COM2 | Common | | | | | |
| 7 | IN1 | Digital control to connect COM to NO | | | | | |
| 8 | V_{+} | Power supply | | | | | |

Table 3. PARAMETER DESCRIPTION

| SYMBOL | DESCRIPTION |
|-------------------------|--|
| V _{COM} | Voltage at COM |
| V _{NO} | Voltage at NO |
| r _{on} | Resistance between COM and NO ports when the channel is ON |
| Δr_{on} | Difference of r _{on} between channels in a specific device |
| r _{on(flat)} | Difference between the maximum and minimum value of ron in a channel over the specified range of conditions |
| I _{NO(OFF)} | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state |
| I _{NO(ON)} | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open |
| I _{COM(OFF)} | Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF state |
| I _{COM(ON)} | Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON state and the output (NO) open |
| V_{IH} | Minimum input voltage for logic high for the control input (IN) |
| V_{IL} | Maximum input voltage for logic low for the control input (IN) |
| V_{I} | Voltage at the control input (IN) |
| $I_{\rm IH},I_{\rm IL}$ | Leakage current measured at the control input (IN) |
| t _{ON} | Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. |
| t _{OFF} | Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. |
| $Q_{\mathbb{C}}$ | Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance and ΔV_{COM} is the change in analog output voltage. |
| $C_{NO(OFF)}$ | Capacitance at the NO port when the corresponding channel (NO to COM) is OFF |
| C _{NO(ON)} | Capacitance at the NO port when the corresponding channel (NO to COM) is ON |
| $C_{COM(OFF)}$ | Capacitance at the COM port when the corresponding channel (COM to NO) is OFF |
| $C_{COM(ON)}$ | Capacitance at the COM port when the corresponding channel (COM to NO) is ON |
| C _I | Capacitance of IN |
| O _{ISO} | OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state. |
| X _{TALK} | Crosstalk is a measurement of unwanted signal coupling from an ON channel to an adjacent ON channel (NC1 to NC2). This is measured in a specific frequency and in dB. |
| BW | Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain. |
| THD | Total harmonic distortion is defined as the ratio of the root mean square (RMS) value of the second, third, and higher harmonics to the magnitude of fundamental harmonic. |
| I ₊ | Static power-supply current with the control (IN) pin at V ₊ or GND |

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PARAMETER MEASUREMENT INFORMATION

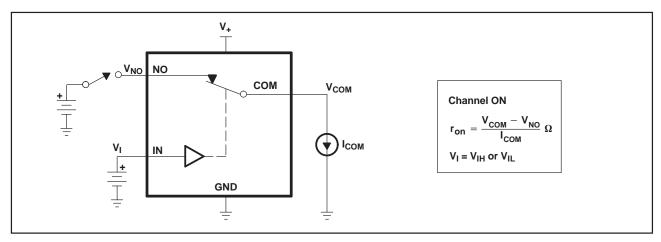


Figure 13. ON-State Resistance (ron)

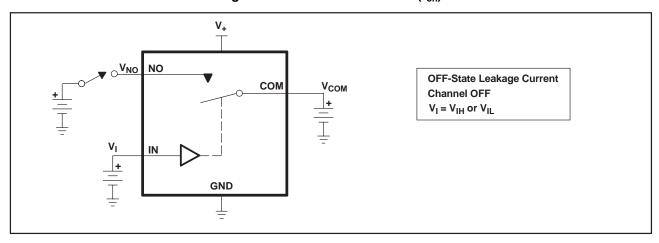


Figure 14. OFF-State Leakage Current (I_{COM(OFF)}, I_{NO(OFF)})

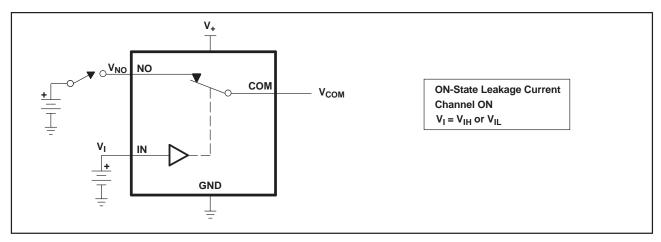


Figure 15. ON-State Leakage Current ($I_{COM(ON)}$, $I_{NO(ON)}$)

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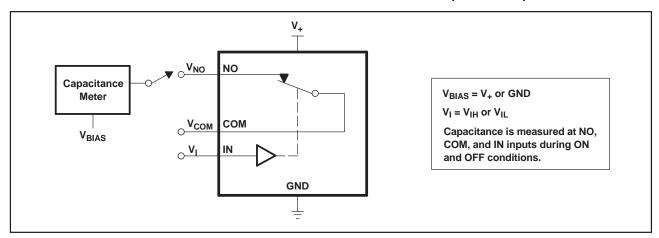


Figure 16. Capacitance (C_I, C_{COM(OFF)}, C_{COM(ON)}, C_{NO(OFF)}, C_{NO(ON)})

- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5$ ns, $t_f < 5$ ns.
- (2) C_L includes probe and jig capacitance.
- (3) See Electrical Characteristics for V_{COM}.

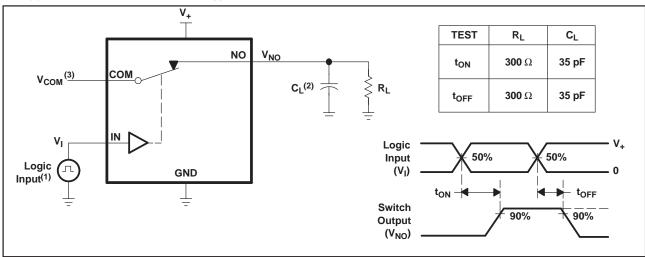


Figure 17. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

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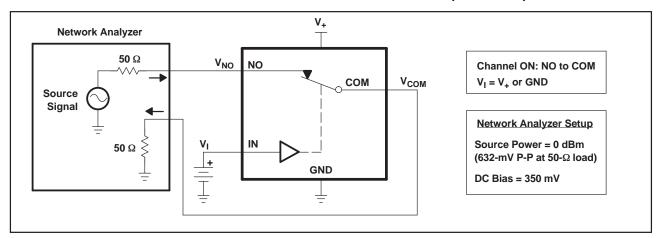


Figure 18. Bandwidth (BW)

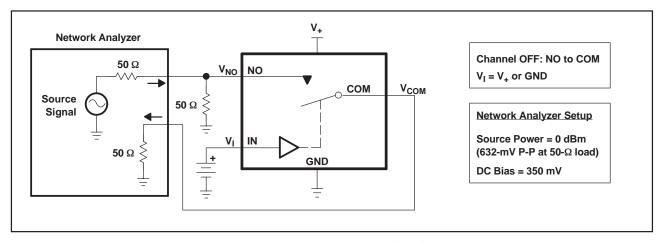


Figure 19. OFF Isolation (O_{ISO})

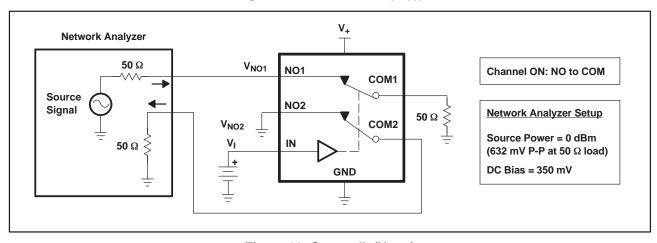


Figure 20. Crosstalk (X_{TALK})

- (4) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5 \text{ ns}$, $t_f < 5 \text{ ns}$.
- (5) C_L includes probe and jig capacitance.

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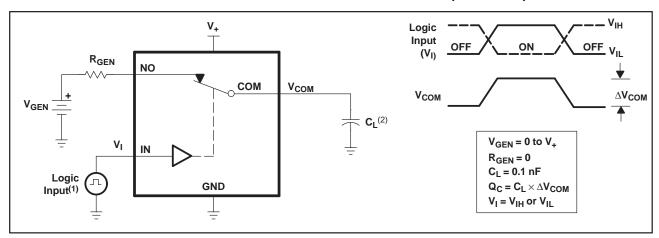


Figure 21. Charge Injection (Q_C)

(6) C_L includes probe and jig capacitance.

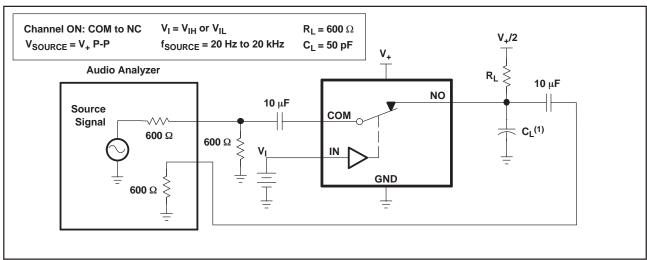


Figure 22. Total Harmonic Distortion (THD)

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PACKAGE OPTION ADDENDUM

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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| TS5A2066DCTR | ACTIVE | SM8 | DCT | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | JAG Z | Samples |
| TS5A2066DCTRE4 | ACTIVE | SM8 | DCT | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | JAG Z | Samples |
| TS5A2066DCUR | ACTIVE | VSSOP | DCU | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | JAGR | Samples |
| TS5A2066DCURE4 | ACTIVE | VSSOP | DCU | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | JAGR | Samples |
| TS5A2066DCURG4 | ACTIVE | VSSOP | DCU | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | JAGR | Samples |
| TS5A2066YZPR | ACTIVE | DSBGA | YZP | 8 | 3000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | (J47 ~ J4N) | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, Til Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (ROHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device

Addendum-Page 1



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PACKAGE OPTION ADDENDUM

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(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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Datasheet of TS5A2066DCUR - IC SWITCH DUAL SPST US8

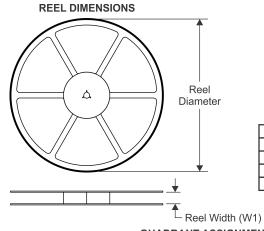
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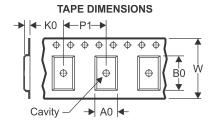


PACKAGE MATERIALS INFORMATION

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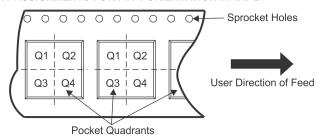
TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TS5A2066DCTR | SM8 | DCT | 8 | 3000 | 180.0 | 13.0 | 3.35 | 4.5 | 1.55 | 4.0 | 12.0 | Q3 |
| TS5A2066DCUR | VSSOP | DCU | 8 | 3000 | 180.0 | 8.4 | 2.25 | 3.35 | 1.05 | 4.0 | 8.0 | Q3 |
| TS5A2066DCURG4 | VSSOP | DCU | 8 | 3000 | 180.0 | 8.4 | 2.25 | 3.35 | 1.05 | 4.0 | 8.0 | Q3 |
| TS5A2066YZPR | DSBGA | YZP | 8 | 3000 | 178.0 | 9.2 | 1.02 | 2.02 | 0.63 | 4.0 | 8.0 | Q1 |

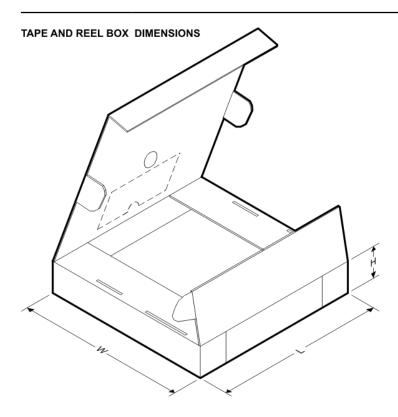
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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TS5A2066DCTR | SM8 | DCT | 8 | 3000 | 182.0 | 182.0 | 20.0 |
| TS5A2066DCUR | VSSOP | DCU | 8 | 3000 | 202.0 | 201.0 | 28.0 |
| TS5A2066DCURG4 | VSSOP | DCU | 8 | 3000 | 202.0 | 201.0 | 28.0 |
| TS5A2066YZPR | DSBGA | YZP | 8 | 3000 | 220.0 | 220.0 | 35.0 |

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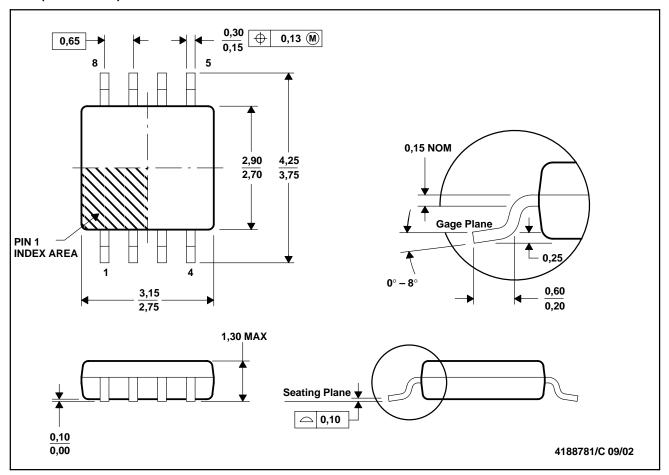
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MECHANICAL DATA

MPDS049B - MAY 1999 - REVISED OCTOBER 2002

DCT (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. Falls within JEDEC MO-187 variation DA.

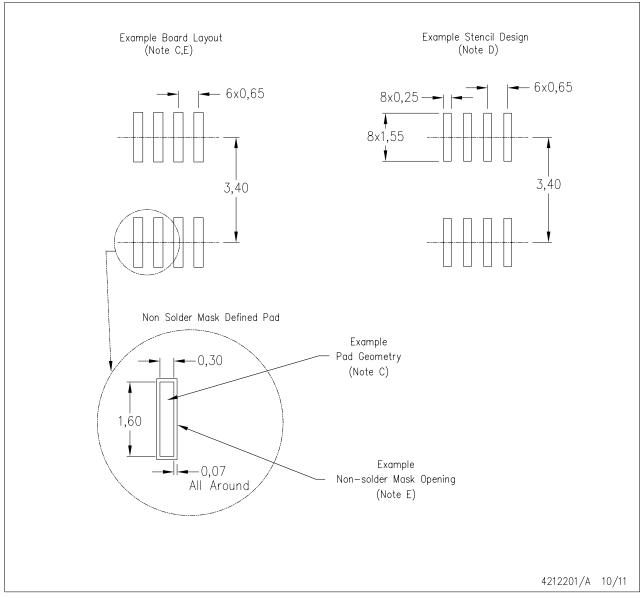




LAND PATTERN DATA

DCT (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in millimeters.

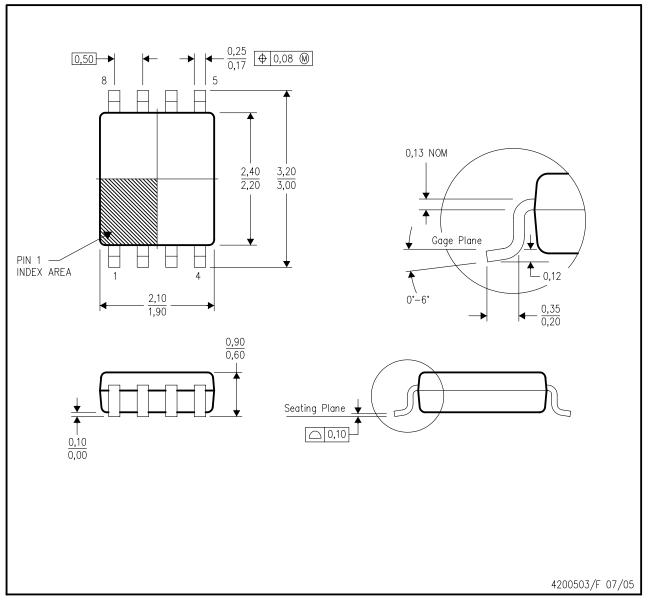
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





MECHANICAL DATA

DCU (R-PDSO-G8) PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-187 variation CA.

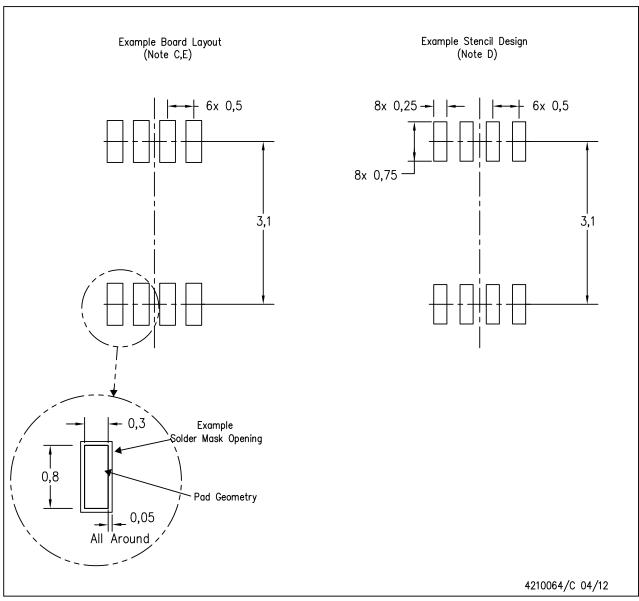




LAND PATTERN DATA

DCU (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

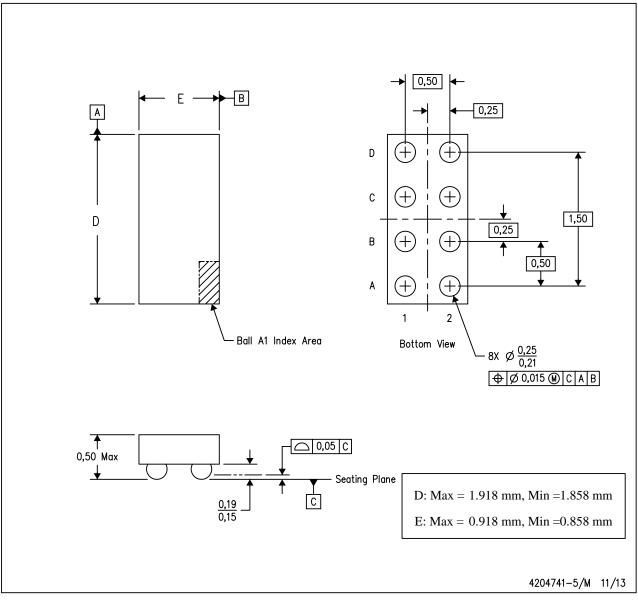




MECHANICAL DATA

YZP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.





Datasheet of TS5A2066DCUR - IC SWITCH DUAL SPST US8

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